



N-Channel 100-V (D-S) MOSFET

CHARACTERISTICS

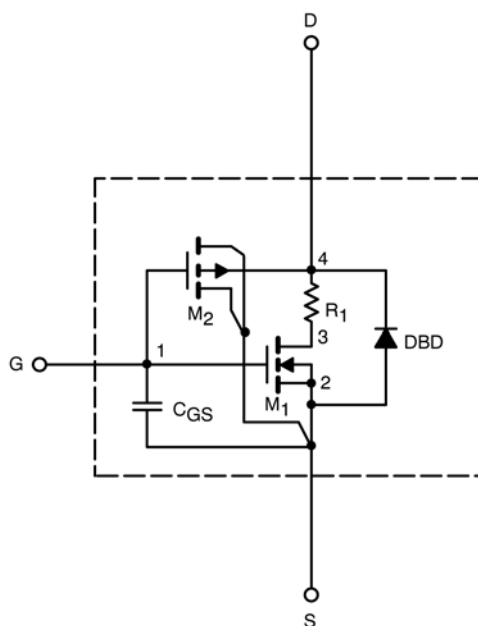
- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125°C temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



SPICE Device Model Si3430DY

Vishay Siliconix



SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)				
Parameter	Symbol	Test Conditions	Typical	Unit
Static				
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	3	V
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\ \text{V}$, $V_{GS} = 10\ \text{V}$	34	A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10\ \text{V}$, $I_D = 2.4\ \text{A}$	0.146	Ω
		$V_{GS} = 6\ \text{V}$, $I_D = 2.3\ \text{A}$	0.154	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\ \text{V}$, $I_D = 2.4\ \text{A}$	8.1	S
Diode Forward Voltage ^a	V_{SD}	$I_S = 1.7\ \text{A}$, $V_{GS} = 0\ \text{V}$	0.72	V
Dynamic^b				
Total Gate Charge ^b	Q_g	$V_{DS} = 50\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 2.4\ \text{A}$	6.06	nC
Gate-Source Charge ^b	Q_{gs}		1.5	
Gate-Drain Charge ^b	Q_{gd}		1.4	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 50\ \text{V}$, $R_L = 50\ \Omega$ $I_D \cong 1\ \text{A}$, $V_{GEN} = 10\ \text{V}$, $R_G = 6\ \Omega$	8	ns
Rise Time ^b	t_r		10	
Turn-Off Delay Time ^b	$t_{d(off)}$		23	
Fall Time ^b	t_f		30	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 1.7\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$	52	

Notes

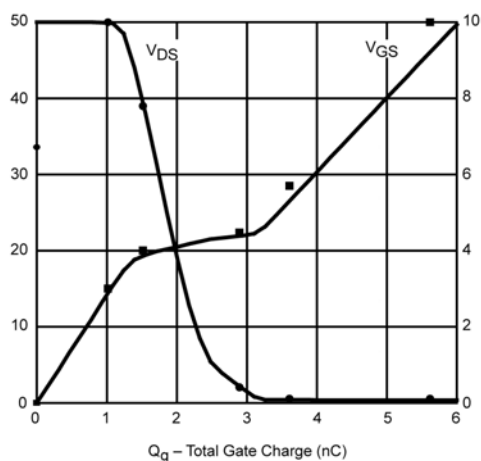
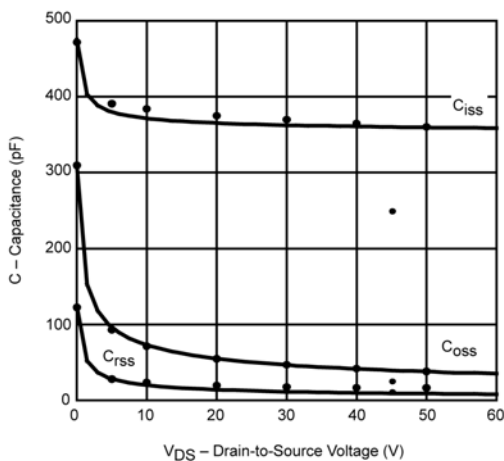
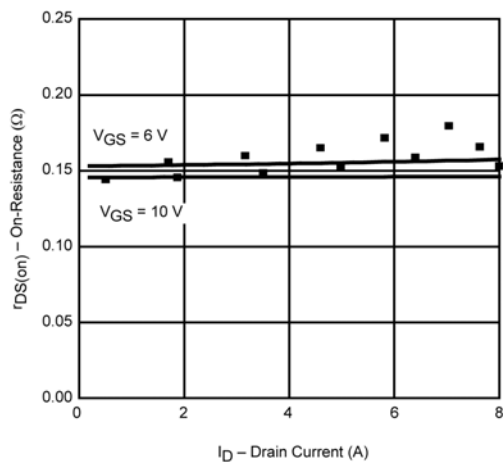
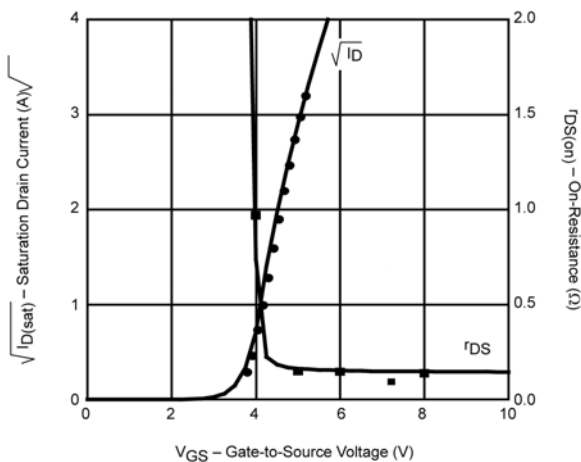
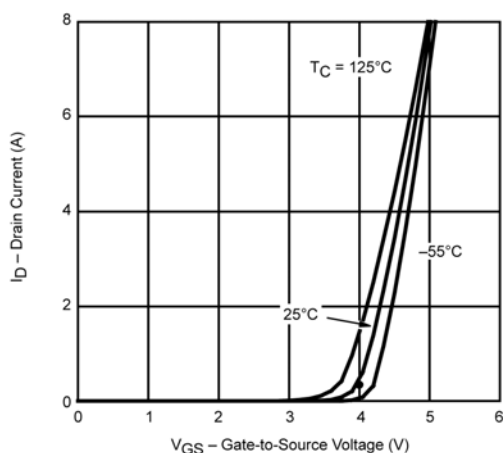
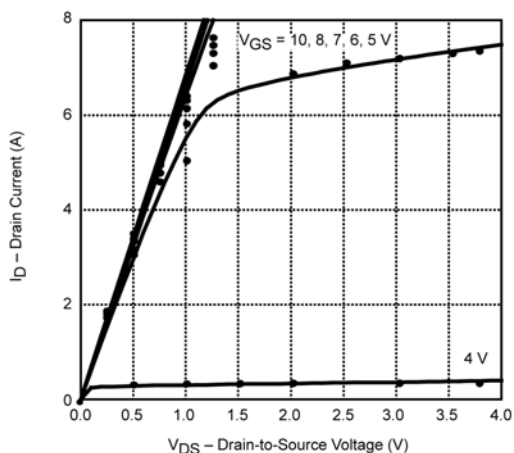
- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing.



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COMPARISON OF MODEL WITH MEASURED DATA ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.



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